

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2243	(257/698,700).ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/05 18:40
L2	1530	(361/792-795).ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/05 18:40
L3	1068	438/125.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/05 18:41
L4	2844	(29/832,852).ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/05 18:41
L5	7296	1 2 3 4	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/05 18:22
L6	250	5 and @pd>="20050802"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/05 18:25
L7	39	6 and ((buil\$1 adj up) decal\$1 hdi hdic (high adj density adj interconnect\$1))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/05 18:35
L8	211	6 not 7	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/05 18:40
L9	776	(257/698,700).ccls.	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/05 18:40
L10	53	(361/792-795).ccls.	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/05 18:40
L11	0	438/125.ccls.	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/05 18:41
L12	1188	(29/832,852).ccls.	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/05 18:41
L13	2010	9 10 12	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/05 18:42
L14	0	13 and @pd>="20050802"	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/05 18:42

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	71	((bull\$1 adj up) and (chip semiconductor ic (integrated adj circuit)) and (via\$1 through\$1hole\$1 feed\$1through\$1)).clm.	US-PGPUB	OR	OFF	2005/12/05 19:08
L2	12	((hdi hdi (high adj density adj interconnect\$1)) and (chip semiconductor ic (integrated adj circuit)) and (via\$1 through\$1hole\$1 feed\$1through\$1)).clm.	US-PGPUB	OR	OFF	2005/12/05 19:09

Interference Search History

